

PS2801-1,PS2801-4

HIGH ISOLATION VOLTAGE SSOP PHOTOCOUPLER

R08DS0096EJ0501 Rev.5.01 July 12, 2019

DESCRIPTION

The PS2801-1 and PS2801-4 are optically coupled isolators containing a GaAs light emitting diode and an NPN silicon phototransistor in a plastic SSOP for high density applications.

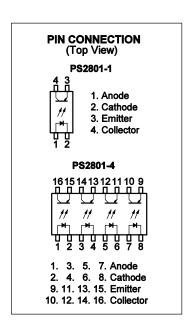
This package has shield effect to cut off ambient light.

FEATURES

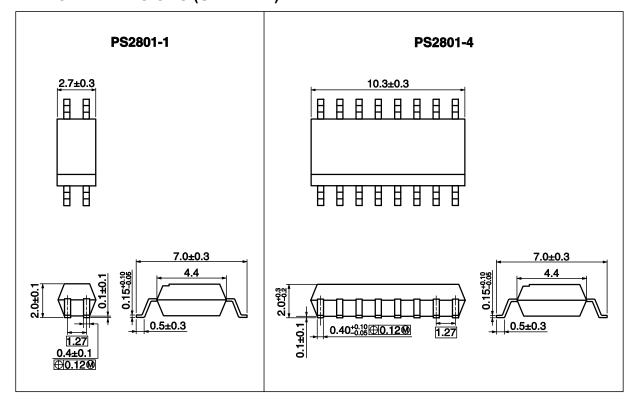
- High isolation voltage (BV = 2 500 Vr.m.s.)
- Small and thin package (4,16-pin SSOP, Pin pitch 1.27 mm)
- High collector to emitter voltage (V_{CEO} = 80 V)
- High-speed switching ($t_r = 3 \mu s$ TYP., $t_f = 5 \mu s$ TYP.)
- Ordering number of tape product: PS2801-1-F3, PS2801-4-F3
- Pb-Free product
- · Safety standards
 - UL approved: UL1577, Single protection
 - CSA approved: CAN/CSA-C22.2 No. 62368-1, Basic insulation
 - BSI approved: BS EN 62368-1, Basic/Supplementary insulation
 - VDE approved: DIN EN 60747-5-5 (Option)

APPLICATIONS

- Programmable logic controllers
- · Measuring instruments
- Power supply
- Hybrid IC



PACKAGE DIMENSIONS (UNIT: mm)

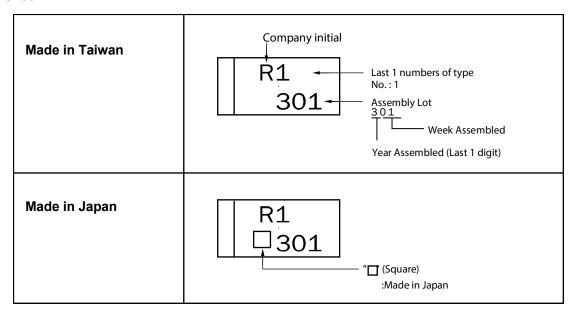


PHOTOCOUPLER CONSTRUCTION

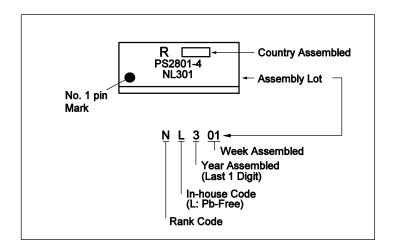
Parameter	Unit (MIN.)
Air Distance	4.5 mm
Creepage Distance	4.5 mm
Isolation Thickness	0.1 mm

MARKING EXAMPLE

PS2801-1



PS2801-4



ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Packing Style Safety Standard Approval		
PS2801-1	PS2801-1-A	Pb-Free	50 pcs (Tape 50 pcs cut)	Standard products	PS2801-1	
PS2801-1-F3	PS2801-1-F3-A		Embossed Tape 3 500 pcs/reel	(UL, BSI, CSA approved)		
PS2801-1-V	PS2801-1-V-A		50 pcs (Tape 50 pcs cut)	UL, BSI, CSA,		
PS2801-1-V-F3	PS2801-1-V-F3-A		Embossed Tape 3 500 pcs/reel	DIN EN 60747-5-5 approved		
PS2801-4	PS2801-4-A		10 pcs (Tape 10 pcs cut)	Standard products	PS2801-4	
PS2801-4-F3	PS2801-4-F3-A	Embossed Tape 2 500 pcs/reel		(UL, BSI, CSA approved)		
PS2801-4-V	PS2801-4-V-A		10 pcs (Tape 10 pcs cut)	UL, BSI, CSA		
PS2801-4-V-F3	PS2801-4-V-F3-A		Embossed Tape 2 500 pcs/reel	DIN EN 60747-5-5 approved		

Note: *1. For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings		Unit
			PS2801-1	PS2801-4	
Diode	Forward Current (DC)	I _F	50		mA/ch
	Reverse Voltage	V_R		6	V
	Power Dissipation Derating	⊿P _D /°C	0.6	0.8	mW/°C
	Power Dissipation	P _D	60	80	mW/ch
	Peak Forward Current*1	I _{FP}	1		A/ch
Transistor	Collector to Emitter Voltage	V _{CEO}	80		V
	Emitter to Collector Voltage	V _{ECO}	(6	V
	Collector Current	Ic	5	0	mA/ch
	Power Dissipation Derating	⊿P₀/°C	1.2		mW/°C
	Power Dissipation	Pc	1:	20	mW/ch
Isolation Vo	oltage*2	BV	2 5	500	Vr.m.s.
Operating Ambient Temperature		T _A	-55 to +100		°C
Storage Temperature		T _{stg}	-55 to +150		°C

Notes: *1. PW = 100 μ s, Duty Cycle = 1%

*2. AC voltage for 1 minute at T_A = 25°C, RH = 60% between input and output. Pins 1-2 shorted together, 3-4 shorted together (PS2801-1). Pins 1-8 shorted together, 9-16 shorted together (PS2801-4).

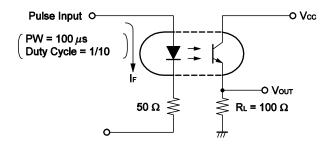
ELECTRICAL CHARACTERISTICS ($T_A = 25$ °C)

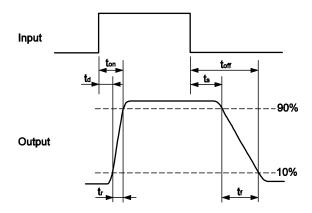
	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	V _F	I _F = 5 mA		1.1	1.4	V
	Reverse Current	I _R	V _R = 5 V			5	μА
	Terminal Capacitance	Ct	V = 0 V, f = 1.0 MHz		15		pF
Transistor	Collector to Emitter Dark Current	I _{CEO}	V _{CE} = 80 V, I _F = 0 mA			100	nA
Coupled Current Tr	Current Transfer Ratio (I _C /I _F)*1	CTR	I _F = 5 mA, V _{CE} = 5 V	80		600	%
	Collector Saturation Voltage	V _{CE (sat)}	I _F = 10 mA, I _C = 2 mA			0.3	٧
	Isolation Resistance	R _{I-O}	$V_{I-O} = 1.0 \text{ kV}_{DC}$	10 ¹¹			Ω
	Isolation Capacitance	C _{I-O}	V = 0 V, f = 1.0 MHz		0.4		pF
	Rise Time *2	t _r	$V_{CC} = 5 \text{ V}, I_C = 2 \text{ mA}, R_L = 100 \Omega$		3		μS
	Fall Time *2	t _f			5		
	Turn-on Time *2	t _{on}			6		
	Turn-off Time *2	t _{off}			5		

Notes: *1. CTR rank (PS2801-1 only)

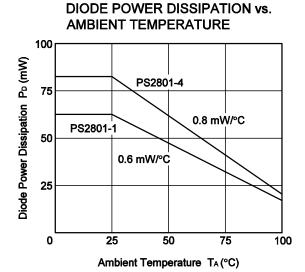
K: 300 to 600 (%)
P: 150 to 300 (%)
L: 100 to 300 (%)
N: 80 to 600 (%)

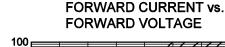
*2. Test circuit for switching time

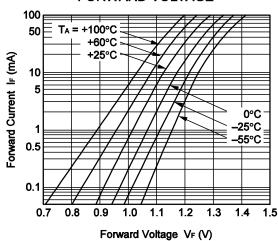




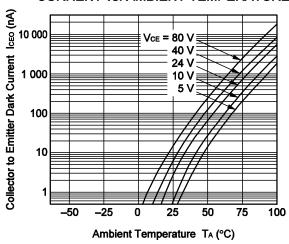
TYPICAL CHARACTERISTICS (T_A = 25°C, unless otherwise specified)





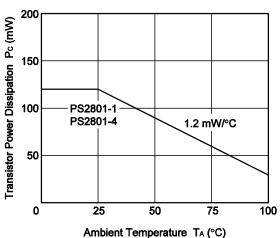


COLLECTOR TO EMITTER DARK CURRENT vs. AMBIENT TEMPERATURE

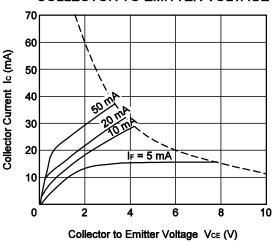


Remark The graphs indicate nominal characteristics.

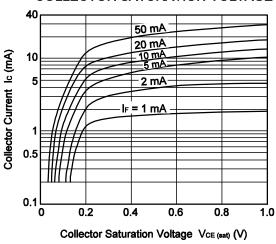
TRANSISTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



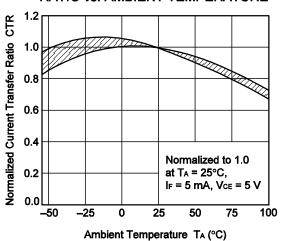
COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE



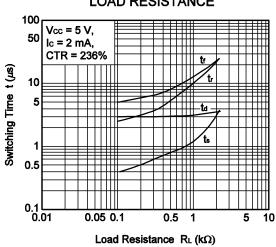
COLLECTOR CURRENT vs. COLLECTOR SATURATION VOLTAGE



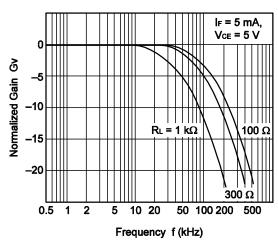
NORMALIZED CURRENT TRANSFER RATIO vs. AMBIENT TEMPERATURE



SWITCHING TIME vs. LOAD RESISTANCE

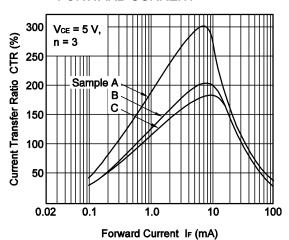


FREQUENCY RESPONSE

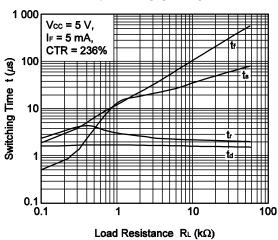


Remark The graphs indicate nominal characteristics.

CURRENT TRANSFER RATIO vs. FORWARD CURRENT

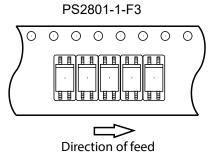


SWITCHING TIME vs. LOAD RESISTANCE

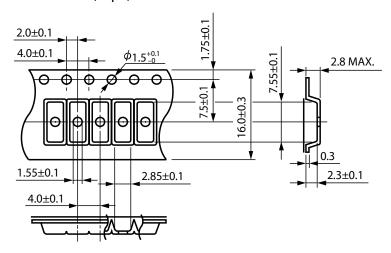


TAPING SPECIFICATIONS (UNIT: mm)

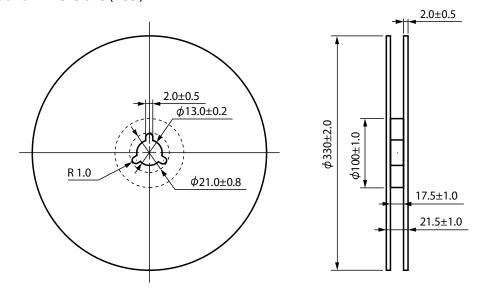




Outline and Dimensions (Tape)

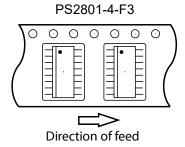


Outline and Dimensions (Reel)

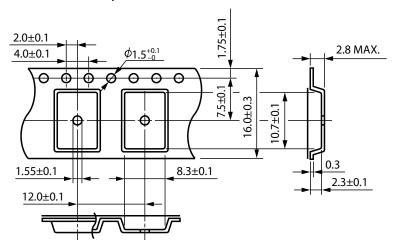


Packing: 3 500 pcs/reel

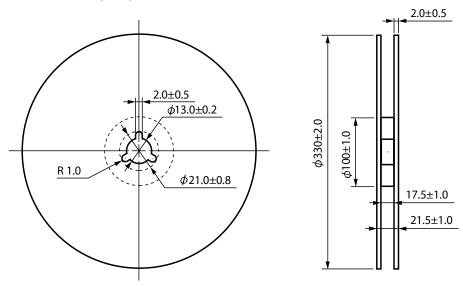
Tape Direction



Outline and Dimensions (Tape)

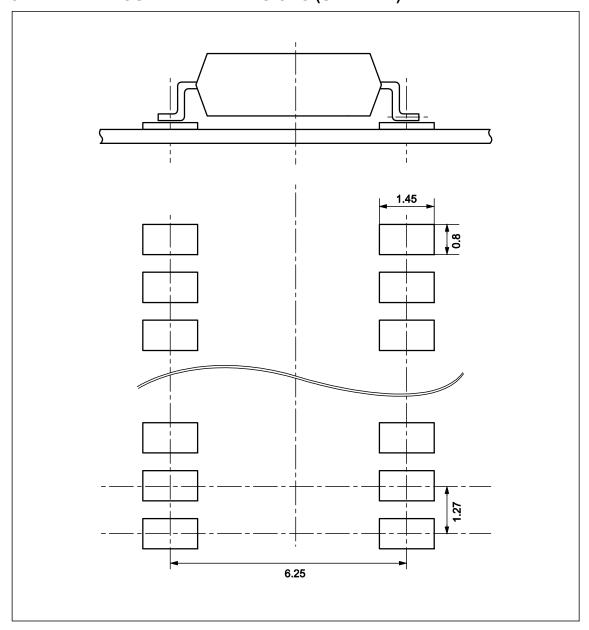


Outline and Dimensions (Reel)



Packing: 2 500 pcs/reel

RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



Remark All dimensions in this figure must be evaluated before use.

NOTES ON HANDLING

- 1. Recommended soldering conditions
 - (1) Infrared reflow soldering
 - Peak reflow temperature 260°C or below (package surface temperature)
 - · Time of peak reflow temperature Time of temperature higher than 220°C
 - Time to preheat temperature from 120 to 180°C 120±30 s

 - Number of reflows
 - Flux

10 seconds or less

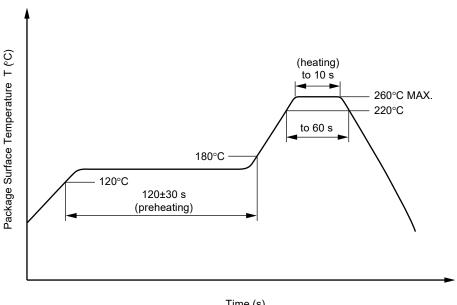
60 seconds or less

Three

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of

0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

 Temperature 260°C or below (molten solder temperature)

 Time 10 seconds or less

· Preheating conditions 120°C or below (package surface temperature)

 Number of times One (Allowed to be dipped in solder including plastic mold portion.) • Flux Rosin flux containing small amount of chlorine (The flux with a maximum

chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

 Peak Temperature (lead part temperature) 350°C or below Time (each pins) 3 seconds or less

• Flux Rosin flux containing small amount of chlorine

(The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead

(4) Cautions

Flux Cleaning

Avoid cleaning with Freon based or halogen-based (chlorinated etc.) solvents.

•Do not use fixing agents or coatings containing halogen-based substances.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

Measurement conditions of current transfer ratios (CTR), which differ according to photocoupler Check the setting values before use, since the forward current conditions at CTR measurement differ according to product.

When using products other than at the specified forward current, the characteristics curves may differ from the standard curves due to CTR value variations or the like. This tendency may sometimes be obvious, especially below $I_F = 1$ mA.

Therefore, check the characteristics under the actual operating conditions and thoroughly take variations or the like into consideration before use.

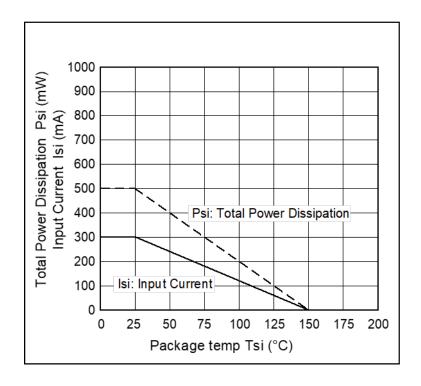
USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

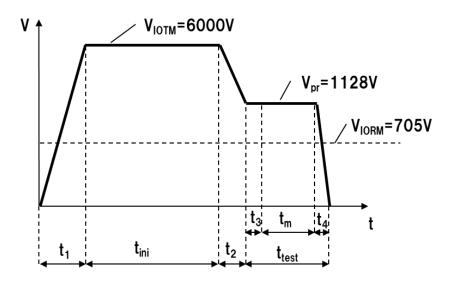
SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Rating	Unit
Climatic test class (IEC 60068-1/DIN EN 60068-1)		55/100/21	
Dielectric strength			
maximum operating isolation voltage	U _{IORM}	705	V_{peak}
Test voltage (partial discharge test, procedure a for type test and	U _{pr}	1 128	V_{peak}
random test)			
U_{pr} = 1.6 × U_{IORM} , P_d < 5 pC			
Test voltage (partial discharge test, procedure b for all devices)	Upr	1 322	V_{peak}
$U_{pr} = 1.875 \times U_{IORM}, P_d < 5 pC$			
Highest permissible overvoltage	U _{TR}	6 000	V_{peak}
Degree of pollution (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1)		2	
Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303-11))	СТІ	175	
Material group (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1))		III a	
Storage temperature range	T _{stg}	-55 to +150	°C
Operating temperature range	TA	−55 to +100	°C
Isolation resistance, minimum value			
V _{IO} = 500 V dc at T _A = 25°C	Ris MIN.	10 ¹²	Ω
V _{IO} = 500 V dc at T _A MAX. at least 100°C	Ris MIN.	10 ¹¹	Ω
Safety maximum ratings (maximum permissible in case of fault, see			
thermal derating curve)			
Package temperature	Tsi	150	°C
Current (input current I _F , Psi = 0)	Isi	300	mA
Power (output or total power dissipation)	Psi	500	mW
Isolation resistance			
V _{IO} = 500 V dc at T _A = Tsi	Ris MIN.	10 ⁹	Ω

Dependence of maximum safety ratings with package temperature



Method a) Destructive Test, Type and Sample Test



 $t_1,t_2=1$ to 10 sec

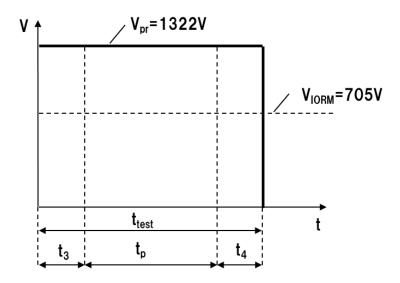
 $t_3, t_4 = 1 \text{ sec}$

 $t_{m \, (PARTIAL \, DISCHARGE)} = 10 \, sec$

 t_{test} =12 sec

t_{ini}=60 sec

Method b) Non-destructive Test, 100% Production Test



 $t_3, t_4 = 0.1 \text{ sec}$

 $t_{p (PARTIAL DISCHARGE)} = 1.0 sec$

 t_{test} =1.2 sec

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
- 1. Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

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В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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